

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	369	174/251	USPAT	OR	OFF	2004/06/27 19:22
S2	2	("4413309" "5650595").PN.	USPAT	OR	OFF	2004/06/27 19:26
S3	0	"6492598".URPN.	USPAT	OR	OFF	2004/06/27 19:26
S4	476	(29/843).CCLS.	USPAT; USOCR	OR	OFF	2004/06/27 19:27
S5	6	("H000487" "3283987" "3451122" "3751801" "4255853" "4715119").PN.	USPAT	OR	OFF	2004/06/27 19:33
S6	4	"5806179".URPN.	USPAT	OR	OFF	2004/06/27 19:33
S7	0	(26/860,861).CCLS.	USPAT; USOCR	OR	OFF	2004/06/27 19:35
S8	470	(29/860,861).CCLS.	USPAT; USOCR	OR	OFF	2004/06/27 19:40
S9	134132	(printed adj circuit) ((circuit wiring hybrid) adj board) pcb pwb hwb (hybrid adj wiring)	USPAT	OR	OFF	2004/06/27 19:41
S10	3398	S9 and (crimp crimped crimping)	USPAT	OR	OFF	2004/06/27 19:42
S11	1092	S10 and solder	USPAT	OR	OFF	2004/06/27 19:48
S12	3	("3383457" "3743748" "5246384").PN.	USPAT	OR	OFF	2004/06/27 19:45
S13	865	(439/83).CCLS.	USPAT; USOCR	OR	OFF	2004/06/27 19:52
S14	42	S13 and (crimp crimped crimping)	USPAT	OR	OFF	2004/06/27 19:52
S15	1	("4993149").PN.	USPAT; USOCR	OR	OFF	2004/06/27 20:25
S16	1	("3955044").PN.	USPAT; USOCR	OR	OFF	2004/06/27 20:25
S17	17	("2022544" "2494137" "2586471" "2909758" "3346690" "3436946" "3443256" "3519982" "4277886").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/09 15:18
S18	24	("5025554").URPN.	USPAT	OR	ON	2004/11/09 15:21

S19	252	(174/251).CCLS.		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/09 15:24
S20	4269	(174/260,261,250).CCLS.		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/09 15:24
S21	58	S20 and (crimp crimped crimping)		US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/09 15:27
S22	2515	(174/262-266).CCLS.		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/09 15:27
S23	33	S22 and (crimp crimped crimping)		US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/09 15:47
S24	5311	(pcb pwb (printed adj circuit) ((circuit wiring) adj board)) and (crimp crimped crimping)		US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/09 15:29
S25	1492	S24 and solder		US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/09 15:29

S26	1354	S25 and (via hole opening aperture)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/09 15:43
S27	1574	(439/83).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/09 15:46
S28	44	S27 and (crimp crimped crimping)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/09 15:47
S29	6	("3808588" "3953103" "3963316" "3995931" "4916804" "4946408"). PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/09 15:50
S30	11	("5772454").URPN.	USPAT	OR	ON	2004/11/09 15:50
S31	6	("3660805" "5762526" "5772454" "5935474" "6375521" "6533609"). PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/09 15:51
S32	0	("6753475").URPN.	USPAT	OR	ON	2004/11/09 15:52
S33	3	("3715457" "3728473" "5772454").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/09 15:55
S36	437	(439/421-424).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/09 16:05
S37	17	("2022544" "2494137" "2586471" "2909758" "3346690" "3436946" "3443256" "3519982" "4277886").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/09 16:11
S38	24	("5025554").URPN.	USPAT	OR	ON	2004/11/09 16:12

S39	12	("3112150" "3953103" "4815200" "4840578" "5025554" "5408048" "5429529" "5736678" "5908326" "5965847" "6107572").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/09 16:12
S40	12	("1631719" "2600012" "3051733" "3522577" "4812138" "4815200" "5025554" "5338233").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/09 16:16
S41	6	("5486653").URPN.	USPAT	OR	ON	2004/11/09 16:17
S42	1576	(439/83).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/18 14:11
S43	6	("3808588" "3953103" "3963316" "3995931" "4916804" "4946408").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/18 14:18
S44	12	("5772454").URPN.	USPAT	OR	ON	2004/11/18 14:19
S45	3	("3715457" "3728473" "5772454").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/18 14:19
S46	1	("6350145").URPN.	USPAT	OR	ON	2004/11/18 14:23
S47	645	(174/84c).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/18 14:32
S48	10	S47 and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 14:23

S49	65	("1052761" "1980890" "2386628" "2530552" "2565477" "2930113" "3184303" "3209792" "3333047" "3358898" "3472944" "3541227" "3548078" "3627191" "3638154" "3688376" "3705047" "3715797" "3726464" "3954572" "3978569" "4079187" "4090768" "4137369" "4161062" "4164606" "4263474" "4298789" "4416408" "4426550" "4431862" "4785988" "4874930" "4876178" "4968550" "5023403" "5052611" "5083698" "5088007" "5094139" "5119106" "5143273" "5239749" "5293001" "5305941" "5334988" "5342996" "5386345" "5769665" "6042932" "6232555").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/18 14:25
S50	15	("2499296" "3141924" "3315218" "3517375" "3828298" "3869187" "5025554" "5061892" "5073128" "5516311" "5962812").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/18 14:26
S51	16	S47 and board	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 14:27
S52	9152	(174/250-268).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/18 14:33
S53	3119	S52 and (wire cable)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 14:33
S54	2249	S53 and (solder soldered soldering)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 15:01
S55	74	S54 and (crimp crimped crimping)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 14:34

S56	4	("3383457" "3743748" "5246384").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/18 14:34
S57	1768	(439/877-882).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/18 14:41
S58	172	S57 and (solder soldered soldering)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 14:41
S59	6	("3808588" "3953103" "3963316" "3995931" "4916804" "4946408").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/18 15:00
S60	12028	(439/775-864).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/18 15:01
S61	885	S60 and (crimp crimped crimping)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 15:01
S62	1032	S60 and (crimp crimped crimping)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 15:01
S63	336	S62 and (solder soldered soldering)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/18 15:05

S64	616	(439/876).CCLS.		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/18 15:06
-----	-----	-----------------	--	---	----	-----	------------------